IXYS

Features:

- µPower Operation (15 µW typical at 25°C)
- Omni polar (switches with N or S pole)
- 2.5 to 5.5 Volt Operation
- Simple Digital Output Interfacing CMOS Push-Pull
- Ultra Low Offset Canceling Amplifiers Provide Sensitive, Accurate, Stable Switching Points and Immunity to Mechanical Stress
- Solid State Circuitry
- Operating Temperature Range: -40°C to +85°C
- RoHS Compliant TSOT-23 3 Lead Package

Ordering Information

Part No.	Description	Qty					
MX887PHTTR	TSOT-23 3L Tape & Reel	3000					

General Description

The MX887P integrated Hall-Effect switch targets the requirements of low-power portable devices with battery operating voltages from 2.5V to 5.5V. Onchip power management circuitry reduces the effective average current to just 5µA at 3.0 VSUPPLY.

The switch output will transition to the Ground potential when either a north or south magnetic pole is applied. The removal of a magnetic field will transition the switch to the Vsupply potential. Emulating the behavior of a traditional reed switch, together with the advantages of high integration and solid state reliability, makes the MX887P is an ideal replacement in low-power portable device applications.

Applications:

- Handheld Portable Devices
- White Goods
- Automotive Body Systems
- Security Systems
- High Reliability Reed Switch Replacement



Functional Block Diagram

Pin Description

Pin No.	Pin Name	Description
1	VSUPPLY	2.5 to 5.5 Volt
2	OUT	CMOS Push-Pull
3	GROUND	Ground

Circuit Description

The MX887P µPower Hall-Effect Switch consists of a Hall element, small signal amplifier, latch, and CMOS push-pull driver. Offset cancellation rejects errors in signal stages and the influence of mechanical stress on the Hall element. This technique together with a precision threshold generator and comparator produce highly accurate magnetic switch points. The Hall element is activated for a small fraction of an operating cycle, then latched in that sample state for the remainder of the period. By using this technique, very low power consumption is achieved.

Electrical Characteristics

Over operating voltage and temperature range unless otherwise noted.

Parameter	Condition	Min	Тур	Max	Unit
Supply Voltage		2.5		5.5	V
Output Leakage Current	VOUT = 5.5V, BRPN < B < BRPS		<1.0	1.0	μA
Output On Voltage	IOUT = 1mA, VDD = 3.0V		100	300	mV
Awake Time				90	μS
Period				90	mS
Duty Cycle			0.1		%
Supply Current	Awake (enabled)			2.0	mA
	Asleep (disabled)			8.0	μA
	Average (Calculated)		5	15	μA
ESD	Human Body Model	2			kV

Notes: 1. Operating and release points will vary with supply voltage.

2. BOPX = operating point (output turns ON); BRPX = release point (output turns OFF).

3. Typical Data is at TA = 25° C and VSUPPLY = 3.0V.

Magnetic Characteristics

Over operating voltage and temperature range unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Operating Points	BOPS	South pole to branded side			60	G
	BOPN	North pole to branded side	-60			G
Release Points	Brps	South pole to branded side	6			G
Release Follows	Brpn	North pole to branded side			-6	G
Hysteresis	Bhys	Bopx – Brpx		5		G

Notes: 1. As use here, negative flux densities are defined as less than zero (algebraic convention) and -50G is less than +10G.

2. BOPX = operating point (output turns ON); BRPX = release point (output turns OFF).

3. Typical Data is at TA = 25° C and VSUPPLY = 3.0V.

MX887P



		[T				
TSDT23 - 3 LEAD			DIMENSIONS					
			INCH			MILLIMETER		
			MIN.	NDM.	MAX.	MIN,	NDM.	MAX.
		A	0.030	-	0.035	0.75	-	0.90
		A1	0.000	-	0.004	0.00	-	0.10
		A2	0.028	0.030	0.031	0.70	0.75	0.80
		b	0.014	-	0.020	0.35	-	0.51
		C	0.004	-	0.010	0.10	-	0.25
			0.110	0.114	0.118	2.80	2.90	3.00
		E	0.102	0.110	0.118	2.60	2.80	3.00
			0.059	0.063	0.067	1.50	1.60	1.70
			0.0374 BSC		0.95 BSC			
			0.0748 BSC		1.90 BSC			
З,	3. PACKAGE TOP MAY BE SMALLER THAN PACKAGE BOTTOM. DIMENSIONS D AND EI ARE DETERMINED AT THE DUTERMOST EXTREME OF THE PLASTIC BODY EXCLUDING MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN TOP AND BOTTOM OF THE PLASTIC BODY.		0.015	-	-	0.37	-	-
			0.0236 REF			0.60 REF		
			0.0098 BSC			0.25 BSC		
2.	2. DIMENSION "E" DOES NOT INCLUDE INTER-LEAD FLASH OR	У	-	-	0.004	-	-	0.10
	PROTRUSIONS. INTER-LEAD FLASH AND PROTRUSION SHALL NOT EXCEED .006″ (0.15MM) PER SIDE.		0.004	-	-	0.10	-	-
1.	 DIMENSION 'D' DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS, DR GATE BURRS. MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED .004 IN. (0.10MM) PER SIDE. 		0°	-	8°	0°	-	8°
			7° NDM			7° NDM		
NΠ	TES: (UNLESS OTHERWISE SPECIFIED)	K2 5° NDM 5° NDM						

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